



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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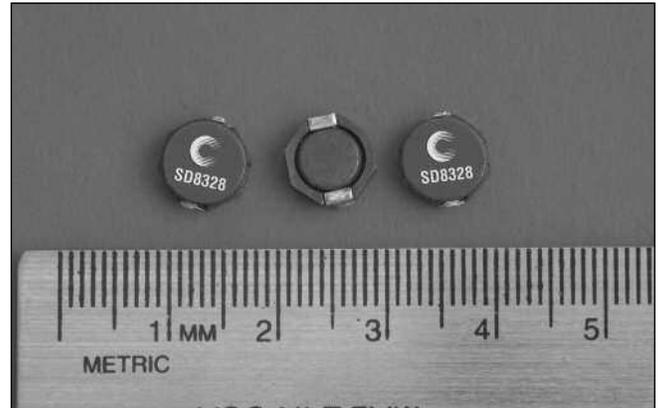
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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Description

- 125°C maximum temperature operation
- Low profile surface mount inductor
- 8.3mm x 9.5mm x 3.0mm shielded drum core
- Ferrite core material
- Inductance range from 2.7µH to 100µH
- Current range from 6.6 Amperes to 0.8 Amperes
- Frequency range up to 1MHz



Applications

- Buck or Boost inductor
- Noise filtering output filter chokes
- Notebook power/display
- LCD Monitors/Displays/Televisions
- Battery chargers, LCD bias supplies
- Battery and Industrial power systems
- Computer, DVD players
- Portable power devices, DC-DC converters

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (range is application specific)
- Solder reflow temperature: +260°C max. for 10 seconds maximum

Packaging

- Supplied in tape and reel packaging, 1280 per reel

Part Number	Rated Inductance (µH)	OCL (1) µH±30%	Irms(2) Amperes	Isat (3) Amperes	DCR (Ω) mΩ @20°C (Typical)	DCR (Ω) mΩ @20°C (Maximum)	K-factor (4)
SD8328-2R5-R	2.5	2.7	6.6	4.5	12	15.6	43
SD8328-3R3-R	3.3	3.4	6.1	4.0	14	18.0	33
SD8328-4R7-R	4.7	5.0	4.5	3.6	19	24.7	23
SD8328-7R3-R	7.3	7.6	3.4	2.9	30	39	15
SD8328-100-R	10	9.1	3.3	2.6	36	45	11
SD8328-150-R	15	14.5	2.35	2.0	53	69	7.2
SD8328-220-R	22	21.1	1.85	1.7	76	99	4.9
SD8328-330-R	33	31.9	1.45	1.4	120	156	3.3
SD8328-470-R	47	44.9	1.30	1.2	150	194	2.3
SD8328-680-R	68	64.2	0.98	1.0	220	286	1.6
SD8328-101-R	100	97.0	0.80	0.8	330	430	1.1

(1) Open Circuit Inductance Test Parameters: 100kHz, 0.1V, 0.0Adc.

(2) Irms: DC current for an approximate ΔT of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

(3) Isat Amperes peak for approximately 35% rolloff (@25°C)

(4) K-factor: Used to determine B p-p for core loss (see graph).

B p-p = K*L*ΔI, B p-p(mT), K: (K factor from table), L: (Inductance in µH), ΔI (Peak to peak ripple current in Amperes).

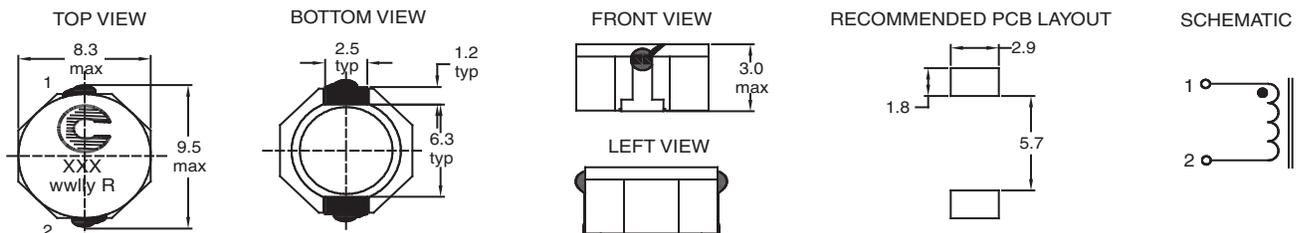
(5) Part Number Definition: SD8328-xxx-R

SD8328 = Product code and size; -xxx = Inductance value in µH;

R = decimal point; If no R is present, third character = # of zeros.

-R suffix = RoHS compliant

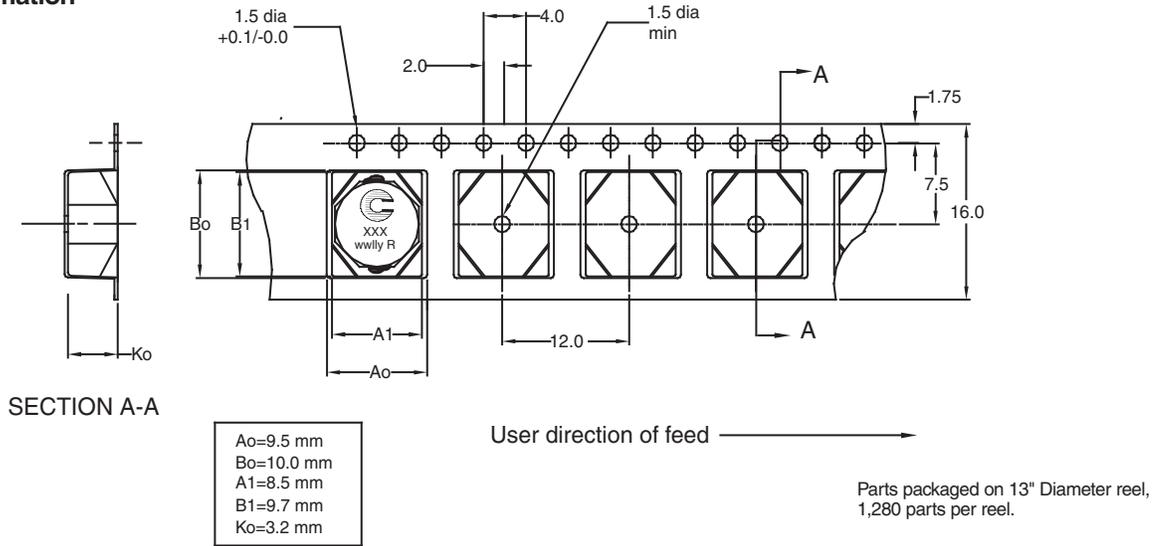
Mechanical Diagrams



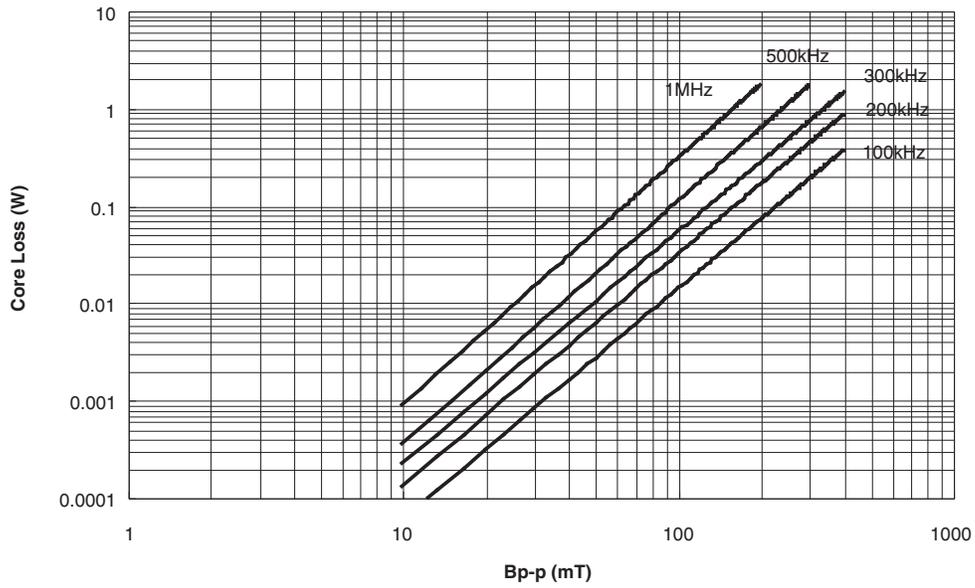
Dimensions are in millimeters.

xxx = Inductance value in µH. R = decimal point. If no R is present third character = # of zeros. wwllly = Date code, R = Revision level.

Packaging Information



Core Loss



Temperature Rise vs. Loss



Inductance Characteristics

OCL Vs. Isat

